



## PRESS RELEASE

### IN Groupe, through its subsidiary SPS, achieves 500 million inductive coupling platforms, a demonstration of the quality and security of its technology

**Smart Packaging Solutions (SPS), a world leader in contactless and dual interface card manufacturing technologies, is proud to announce it has delivered its 500 millionth inductive coupling platform building upon the quality and reliability of its technology delivering ultimate customer satisfaction.**

**ROUSSET, FRANCE, June 21, 2018** – Smart Packaging Solutions (SPS) is recognized as a worldwide leader in subsets for smart card manufacturing thanks to its inductive coupling technology. With a production capacity that doubles every two years, the company has now delivered over 500 million eBoost® inductive coupling platforms for diverse markets segments worldwide.

Smart Packaging Solutions (SPS) started with a strong belief that inductive coupling was bringing definite advantages to the smart card market. In 2007, the first organization to deploy inductive coupling technology for a national application was the government of Morocco for its national ID card. Now in 2018, cards are still on the field and new ID cards are issued every day to Moroccan citizens.

Now, thanks to years of permanent R&D leading to an always-improved level of quality and security, SPS eBoost® inductive coupling technology is widely adopted across all segments: payment, identity for cards and passports as well as mass-transit. All types of documents can benefit from the advantages of the technology: contact cards, contactless cards, hybrid (contact and contactless with two chips) and dual interface (single chip contact and contactless). Inductive coupling technology is qualified for a variety of materials: PVC, PET and PC (polycarbonate).

As a result of SPS continuous innovation, inductive coupling is recognized as a market standard. The technology is widely adopted to build dual interface payment cards. A decisive migration movement is happening in the Americas as payment networks and financial institutions have decided to distribute dual interface cards on a massive scale to their cardholders. SPS inductive coupling brings its decisive advantages of quality and security to support card vendors in tackling this highly attractive market.

SPS eBoost® inductive coupling is adopted by numerous card manufacturers worldwide as it allows them to evolve easily from contact cards to dual interface, hybrid and contactless cards while keeping the same equipment and the same process. High yields and insignificant return rates ensure that the whole process is extremely cost-effective and brings a high level of satisfaction for the issuers.

SPS inductive coupling is compatible with all chips and operating systems delivered by leading manufacturers for the smart card industry. SPS supports card manufacturers at all steps, from the selection process for card bodies and modules all the way to onsite support and precertification.

Didier Trutt, Chairman & CEO of IN Groupe declares: “The fact we have delivered 500 million eBoost® inductive coupling platforms is a recognition of SPS innovative technology and its customer focus for all market segments: identity, payment and mass-transit.”



IN Groupe / Smart Packaging Solutions (SPS) will be exhibiting on booth B14 (3<sup>rd</sup> floor) at SDW, a world-leading event providing a global showcase for next-generation human identity solutions, taking place at the QEII Centre, London, UK, on June 25-27, 2018. Come and visit us!

As a part of the event, Joachim Caillosse, Product Manager – ID and Travel Documents, IN Groupe, will deliver a speech at 11.30am on Wednesday 27 June, titled “Fraud on polycarbonate documents: Trends and technical answers from a manufacturer.”

### About SPS

Smart Packaging Solutions is specialized in the design, manufacturing and sale of contactless solutions dedicated to ID cards, e-passport and dual interface banking cards. Headquartered in Rousset, France, with a subsidiary in Singapore, SPS employs 140 people. Part of the French IN Groupe, the company specializes in contactless and dual-interface products, with a recognized micro packaging expertise. SPS has filed over 120 patents supporting its exclusive technologies. More information at <http://www.s-p-s.com>

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SPS is part of IN Groupe.



The IN Groupe is a global leader in secure identity solutions.

In a mobile and digital world where data security has become the major issue, the IN Groupe offers States, governments and businesses trusted solutions including added value electronic components for banking, identity solutions including electronic components, cutting-edge secure credentials and safe and reliable interoperable systems, but also innovative and efficient digital services, and secure solutions for complex printings and workflows.

Real engineering company, the IN Groupe is specialized in the integration of electronic and biometrics in identity documents and in polycarbonate cards. Thanks to its innovative new products and its strengthened security, the IN Groupe has become a worldwide leader with major customers in over 68 countries.

Based in Paris, the IN Groupe has two production centers and employs more than 900 employees, of which over a third is dedicated to technology development.

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